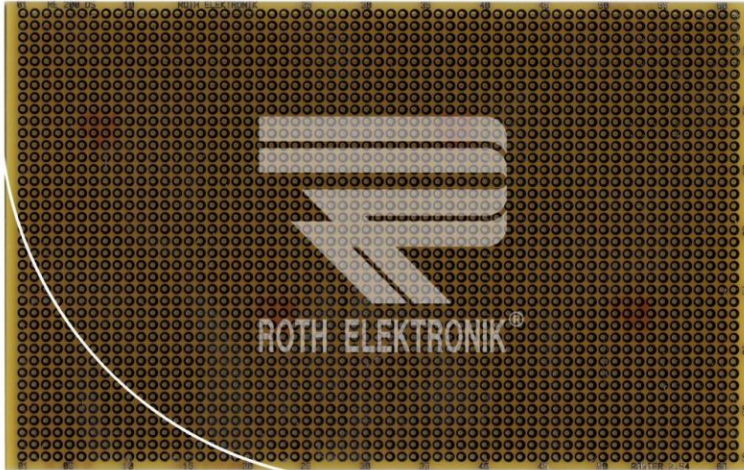


## Prototyping Boards Dual Inline



### RE200-DSPT

- EPOXY fibre-glass FR4 1.5 mm double-sided 35 µm CU (plated through holes)
- hot air leveling (HAL-leadfree)
- 38 x 61 single-hole conductor 2.2 mm Ø
- hole spacing 2.54 x 2.54 mm
- hole dia 1.0 mm
- size 100 x 160 mm